MOTOROLA
Personal Communications Sector

GSM Service Support Level 3 Authorized

GSM Service Support
Training - Documentation - Engineering

W206 W213

Level 3
Circuit Description
15 August 2007
V1.0

Index

1 Receive

1.1 Band selection

The radio frequency signal is received from internal PIFA-type antenna. Received GSM RF signal enters to PCB through the RF switch JP201. At this moment the T/R switch SW201 is switched to RX mode to let the signal input to next stage. Then the signal goes into SAW filter, BF201 and BF202 , which reject out-band signal and transfer the signal from single-end to balanced. And the matching circuits between T/R switch and SAW filter reduce the unwanted RF signal reflection and provide a flat frequency response in the operation band. Finally the received signal will fed into Locosto Plus U101 DRP core through a balanced MLCC matching network. The following table describes the control voltages of T/R switch and PA:

W375 EU	**SW_LO_TX** PIN 5 of T201	**SW_HI_TX** PIN 2 of T201	**PA_EN** TP201	**VAPC** PIN 20 of U201	**BS1** TP202
Standby	Low	x	Low	Low	x
RX EGSM900	Low	Low	Low	Low	Low
RX DCS1800	Low	Low	Low	Low	High
TX GSM900	High	High	High	High	Low
TX DCS1800	High	High	High	High	High

The RF signal is received by internal antenna or by RF plug, and the signal is passing through the RF switch JP201 and then fed into T/R switch. The low band (GSM900) RX received signal is transmitted from SW201 (**Pin 11**) and input to low-band SAW filter BF201, while the high band (DCS1800) RX received signal from SW201 (**Pin 1**) and then input to high-band SAW filter BF202. The last stage of RX on PCB is Locosto U101 (Loocsto-Plus), and the DRP process will make the signal into binary data.

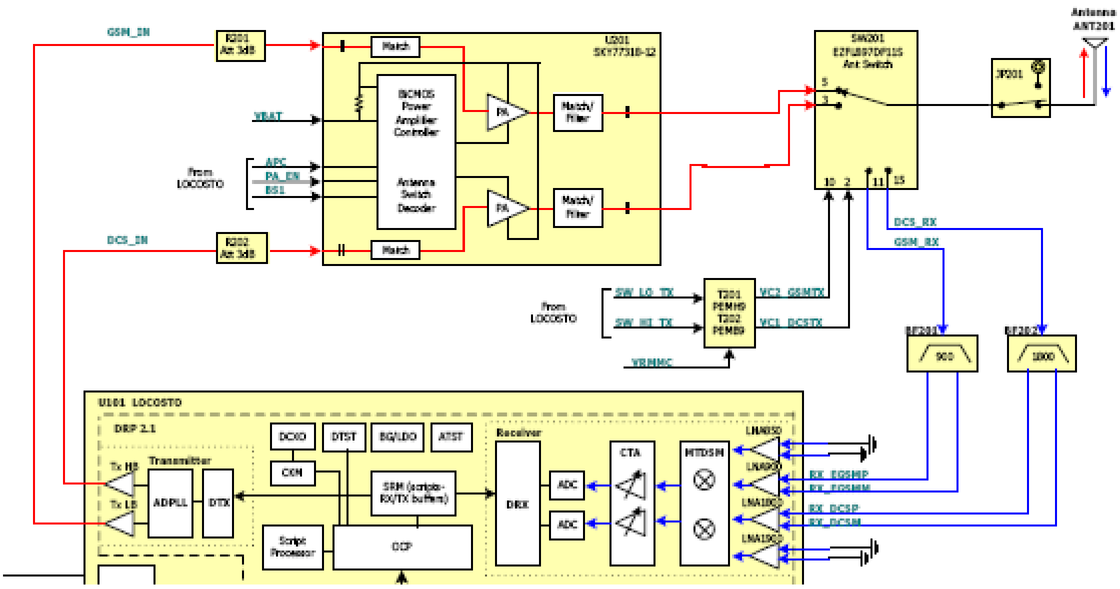


Figure 1: Locosto TX/RX Paths Description

1.2 Locosto RX Mode

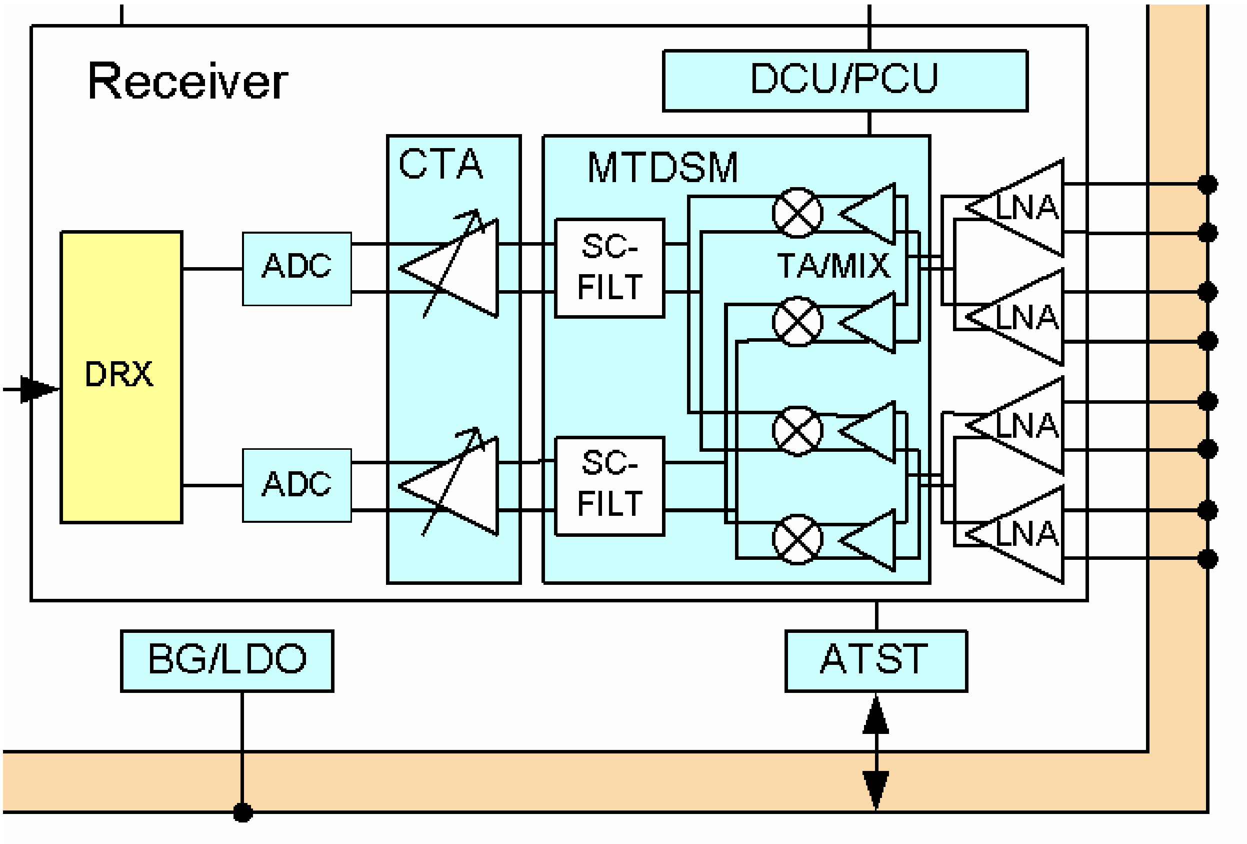
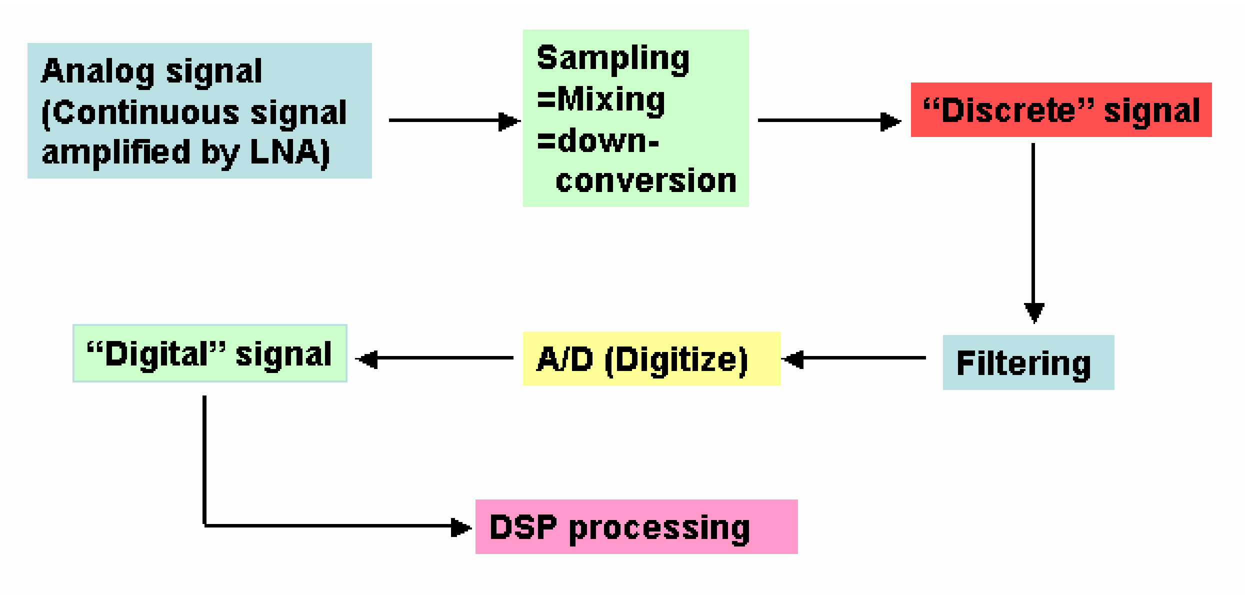


Figure 2: Locosto RX Signal Process

As described in Figure 2, when the RF signal is input to Locosto, it will be amplified by a differential LNA in advance, in order to obtain a better NF in the last receiving stage. And then it will be turned into discrete IF signal by a high-speed mixer. After passing through a filter and an A/D converter, the discrete signal will become digital signal and then input to Locosto core to do DSP process. The detail RX signal route is depicted as below:



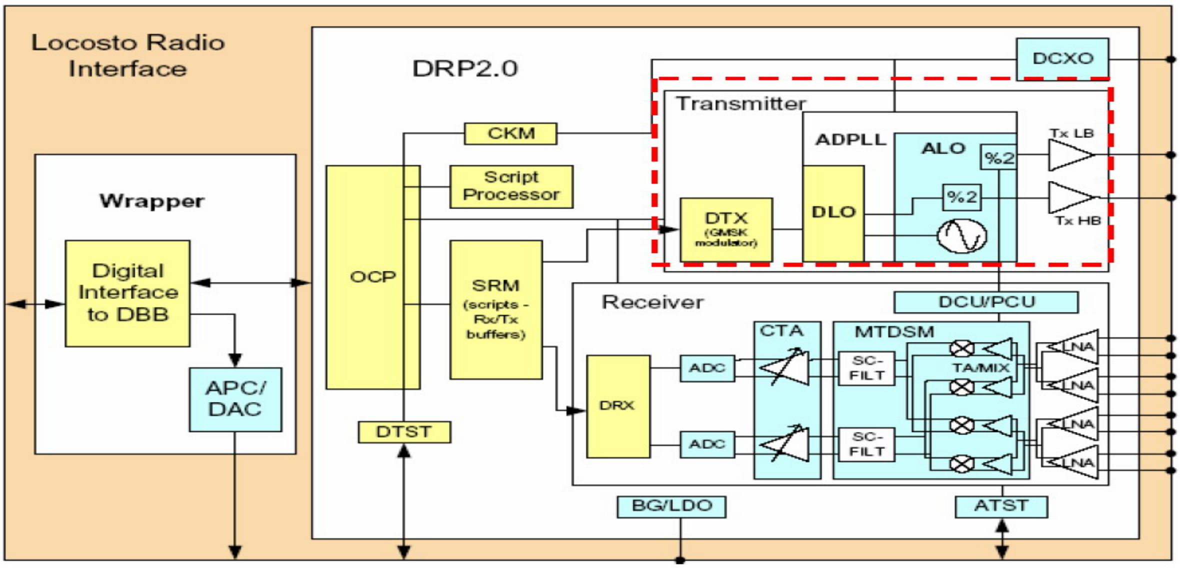


Figure 3: Baseband Downlink Block Diagram

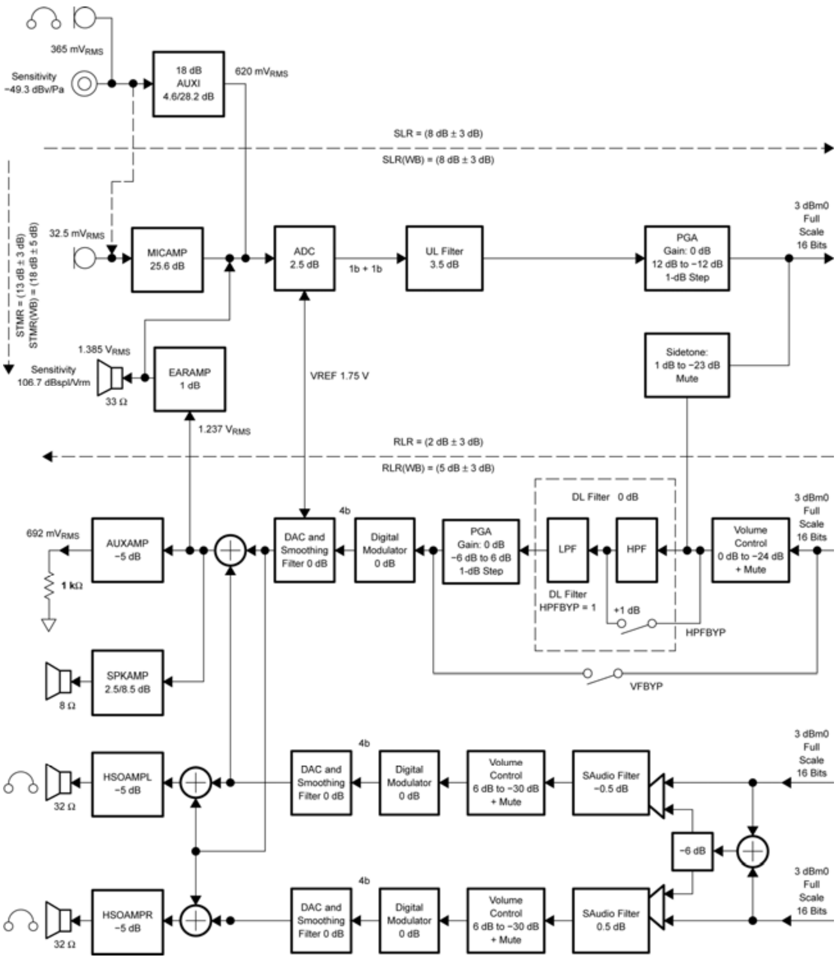


Figure 3: Audio Codec Block Diagram

1.3 Audio Codec

The Audio codec consist of a voice codec dedicated to GSM application and an audio stereo line. The voice codec circuitry processes analog audio components in the uplink path and applies this signal to the voice signal interface for eventual baseband modulation. In the downlink path, the codec circuitry changes voice component data received from the voice serial interface into analog audio. The voice codec support an 8/16 kHz sampling frequency. The stereo audio path converts audio component data received from the I2S serial interface into analog audio. The following paragraphs describe these uplink/downlink and audio stereo functions in more details.

1.3.1 Voice Downlink Patch

The VDL path receives speech samples at the rate of 8 kHz from the Locosto-Plus IC U101 (DSP) via the VSP and converts them to analog signals to drive the external speech transducer.

The digital speech coming from the Locosto-Plus IC U101 (DSP) is first fed to a speech digital filter that has two functions. The first function is to interpolate the input signal and to increase the sampling rate from 8 kHz up to 40 kHz to allow the digital-to-analog conversion to be performed by an over-sampling digital modulator. The second function is to band-limit the speech signal with both low-pass and high-pass transfer functions. The filter, the PGA gain, and the volume gain can be bypassed by programming.

The interpolated and band-limited signal is fed to a second order Σ-Δ digital modulator sampled at 1 MHz to generate a 4-bit (9 levels) over-sampled signal. This signal is then passed through a dynamic element-matching block and then to a 4-bit digital-to-analog converter (DAC).

Due to the over-sampling conversion, the analog signal obtained at the output of the 4–bit DAC is mixed with a high frequency noise. Because a 4–bit digital output is used, a first–order RC filter (included in the output stage) is enough to filter this noise.

The volume control and the programmable gain are performed in the TX digital filter. Volume control is performed in steps of 6 dB from 0 dB to -24 dB. In mute state, attenuation is higher than 40 dB. A fine adjustment of gain is possible from -6 dB to +6 dB in 1–dB steps to calibrate the system depending on the earphone characteristics. The earphone amplifier provides a full differential signal on the terminals **EARP** Triton-Lite **Pin J2** and **EARN** Triton-Lite **Pin H2**. The 8Ohm speaker amplifier provides a differential signal on the terminals **SPKP** Triton-Lite **Pin L6, K6** and **SPKN** Triton-Lite **Pin M6, M7**.

1.4 Earpiece Receiver

The Receiver J10 is connected to **EARP** Triton-Lite **Pin J2** and **EARN** Triton-Lite **Pin H2**.

1.5 Headset

The headset uses a standard 2.5mm phone jack. The headset circuit contains analog switches (U602 and U605), which are normally switched to receiver earpiece after power on. When system turns on, the signal **HS_EN** (U101 **Pin T3**) are applied. When earphone plug in, the phone will detect this action and make an appropriate response to answer a call while incoming call occur. The interrupt for the headphones is detected on the **HS_DETECT** (U101 **Pin C6**) line from Pin 6 of Headset Jack J602. This signal will be pulled to high when the headset is connected.

1.6 Speaker Phone

When the handset set the hand-free mode, the Triton-Lite will switch from **EARP**/**EARN** to **SPKP**/**SPKN** trace and receiver signal will be through Audio amplifier U601 to Speaker.

1.7 Data Download Receive Path

The External download cable is connected to the Earphone Jack J602, the headset connector of the mobile phone. The download path is routed from J602 **Pin 2** via U602 **Pin 1** and **U607 Pin C1** to **RX_Modem**. The **RX_Modem** signal connects to Locosto-Plus IC U101 **Pin L7** to provide this capability. When software is set to download mode, the signal **HS_EN** (U101 **Pin T3**) is applied high, the phone will entered to download state till download cable pulls out.

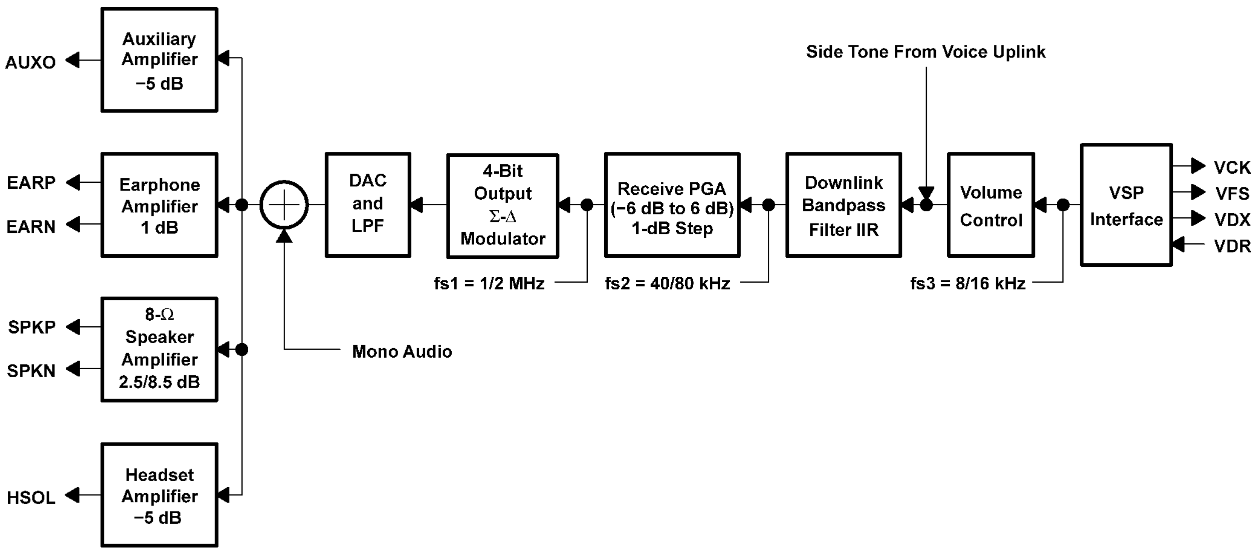


Figure 4: Voice Codec Downlink Patch

1.8 FM radio (only available for W213)

The headphone antenna (J602) is used with a standard 2.5mm phone jack. Silicon Lab Si4702 (U202) demodulated the FM radio. The left and right audio channels are driven by Triton_Lite (U103) audio amplifier onto left and right audio path and common audio connector is used for the audio return path and FM antenna.

2 Transmit

2.1 Audio (Voice uplink Patch)

The VUL path includes two input stages. The first stage is a microphone amplifier, compatible with electric microphones containing a FET buffer with open drain output. The microphone amplifier has a gain of typically 25.6 dB (±1 dB) and provides an external voltage of 2.5V to bias the microphone (**HS_BIAS** Locosto-Plus **Pin K8**).

The auxiliary audio input can be used as an alternative source for higher-level speech signals. This stage performs single-ended conversion and provides a programmable gain of 4.6 dB or 28.2 dB. The third stage is a headset microphone amplifier, compatible with electric microphones. The headset microphone amplifier has a gain of typically 18 dB and provides an external voltage of 2.0V or 2.5V to bias the headset microphone (**HS_BIAS** Locosto-Plus **Pin K8**). When one of the input stages (**HSMIC**) is in use, the other input stages are disabled and powered down.

The resulting fully differential signal is fed to the analog-to-digital converter (ADC). The ADC conversion slope depends on the value of the internal voltage reference.

Analog-to-digital conversion is performed by a third-order Σ-Δ modulator with a sampling rate of 1 MHz. Output of the ADC is fed to a speech digital filter, which performs the decimation down to 8 kHz and band-limits the signal with both low-pass and high-pass transfer functions. Programmable gain can be set digitally from –12 dB to +12 dB in 1-dB steps. The speech samples are then transmitted to the Locosto-Plus IC U101 via the VSP at a rate of 8 kHz. There are 15 meaningful output bits.

Programmable functions of the VUL path, power-up, input selection, and gain are controlled by the Baseband serial port (BSP) or the MCU serial port (USP) via the serial interfaces. The VUL path can be powered down by Program.

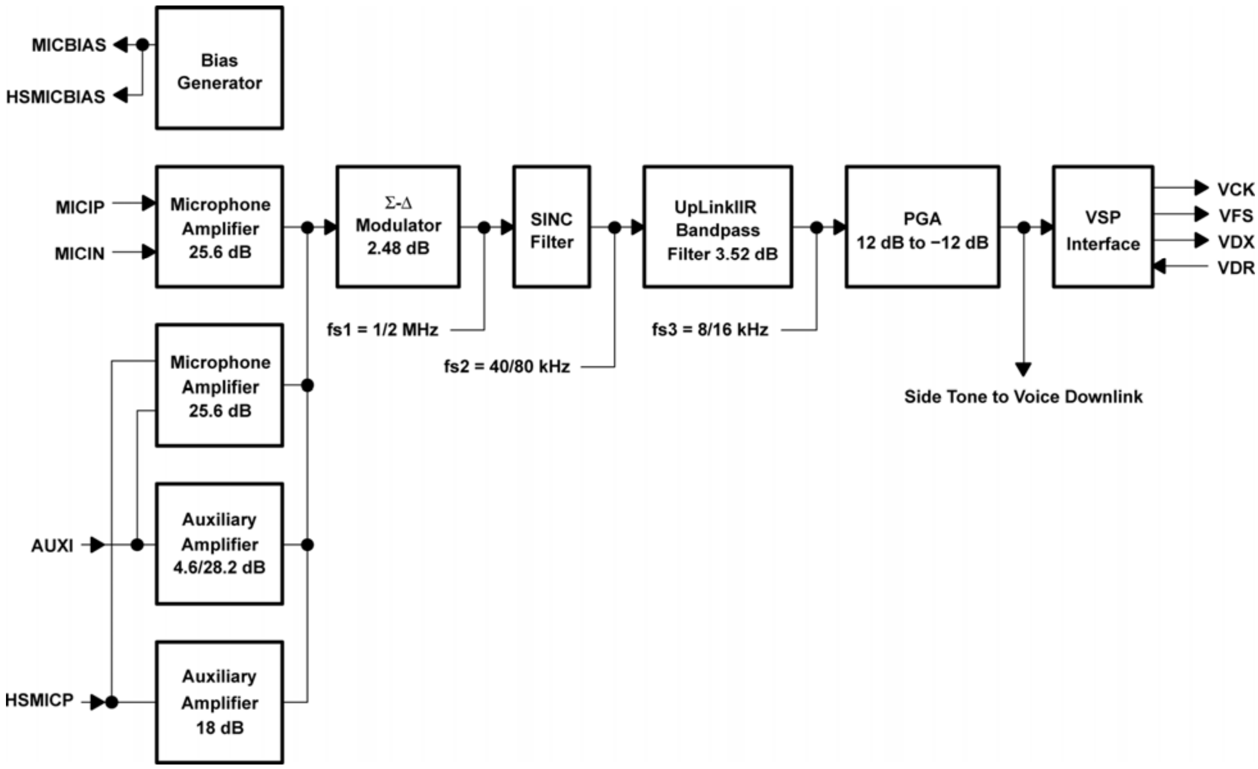


Figure 5: Voice Uplink Paths

2.2 Data Download Transmit Path

The External download cable is connected to the Earphone Jack J602 **Pin 3**, the headset connector of the mobile phone. The download path is routed from J602 **Pin 3** via U605 **Pin 1** and U608 (Level shifter) **Pin C2** to **TX_Modem**. The **TX_Modem** signal connects to Locosto-Plus IC U101 **Pin P3** to provide this capability. When software is set to download mode, the signal HS_EN (U101 **Pin T3**) is applied low, the phone will entered to download state till download cable pull out.

2.3 Stereo Audio Path

The stereo audio path receives Left and right signal samples at the rate of a programmable frequency, from 8kHz to 48kHz, via the I2S serial interface and converts them to analog signals to drive the external audio signal or speech transducers.

The digital audio signal is first fed to an audio digital filter that has two functions. The first function is to interpolate the input signal and to increase the sampling rate to allow the digital–to–analog conversion to be performed by an over-sampling digital modulator. The second function is to band–limit the audio signal with a low–pass transfer functions. The interpolated and band–limited signal is fed to a second order Σ-Δ digital modulator sampled at fS1 frequency to generate a 4–bit (9 levels) over-sampled signal. This signal is then passed through a dynamic element matching block and then to a 4–bit digital–to–analog converter (DAC).

Due to the over-sampling conversion, the analog signal obtained at the output of the 4–bit DAC is mixed with a high frequency noise. Because a 4–bit digital output is used, a first–order RC filter (included in the output stage) is enough to filter this noise.

The volume control is performed in the audio digital filter. Volume control is performed in steps of 1 dB from 0 dB to -30 dB. In mute state, attenuation is higher than 40 dB. The gain is independently programmable on the Left and Right channels, using the same register VAUSCTRL. A common adjustment of gain is possible at 0dB or +6dB. A digital Left/Right summer and 6dB attenuator allows output of a mono audio path. These configurations are programmed with the register VAUDCTRL.

The Left and right head set amplifiers provide the stereo signal on terminals **HSOL** (U103 **Pin G1**) and **HSOR** (U103 **Pin F1**). The mono audio signal may be provided on the Right or the Right and Left headset outputs. The mono audio signal may be sum to the speech signal and provided on the Auxiliary, Earphone and/or 8Ohm Speaker outputs. The Audio Stereo/Mono path can be powered down and configure with the PWDNG, VAUDCTRL and VAUDPLL registers.

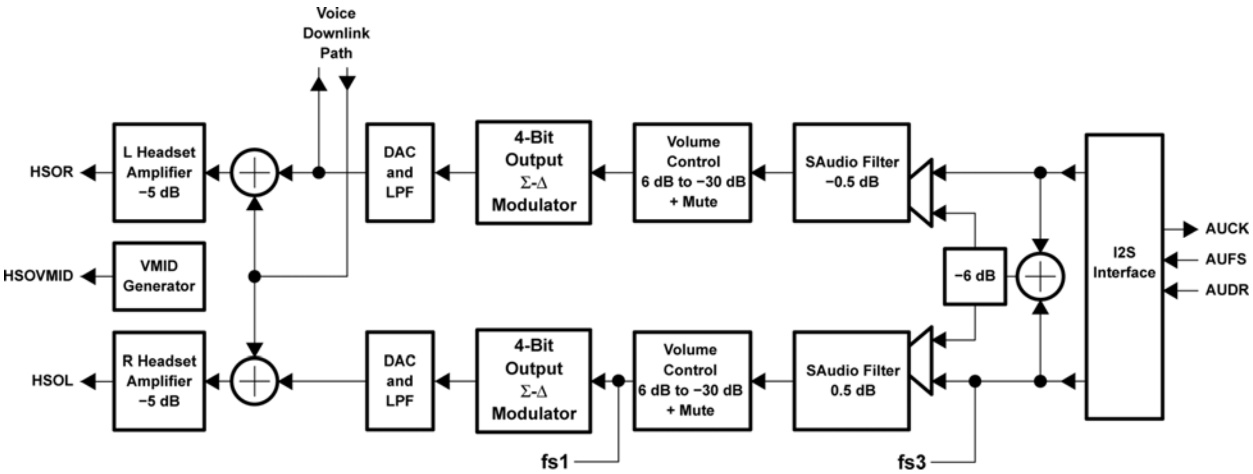


Figure 6: Stereo Audio Path

2.4 Modulation

As illustrated in Figure 8, GMSK 0.3 is generated with Gaussian low-pass filtered bipolar data, applied to a DC coupled FM modulator, set to a modulation index of 0.5.

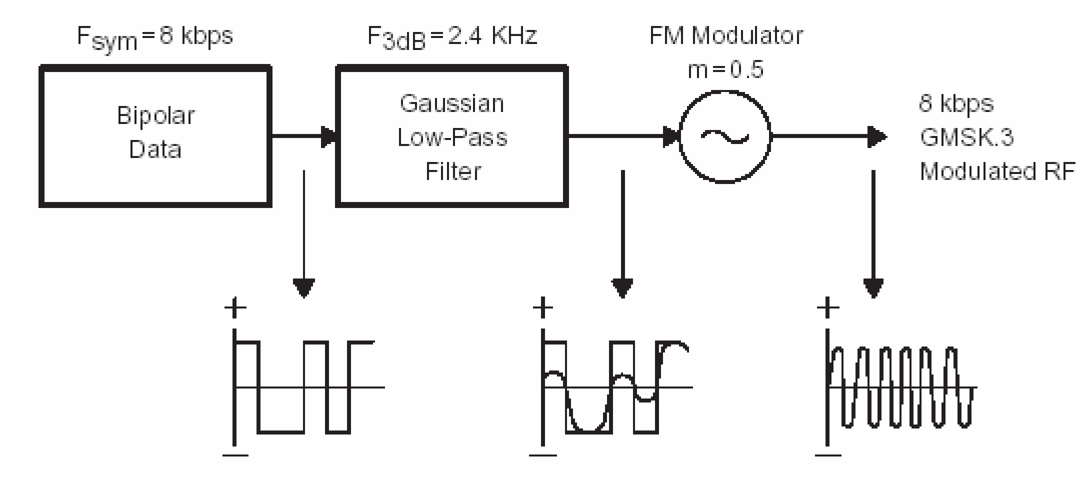


Figure 7: GMSK Modulation

2.4.1 Transmit Section

As compared with a traditional VCO, TI takes advantage of DCO scheme to design the main TX oscillator in Locosto. DCO stands for "digitally controlled oscillator", which uses some digital switched capacitances to do frequency tuning, but it should be noticed that the oscillator core is still analog. And Locosto DRP uses ADPLL (all digital phase lock loop) architecture to design a digital synthesizer, and its reference frequency is provided by 26MHz DXCO. The ADPLL output signal will be pre-amplified by a digital controlled pre-PA and then fed into PA module. The TX signals output at **TXLB** Locosto Plus **Pin F17** (low-band) and **TXHB** Locosto Plus **Pin G17** (high-band).

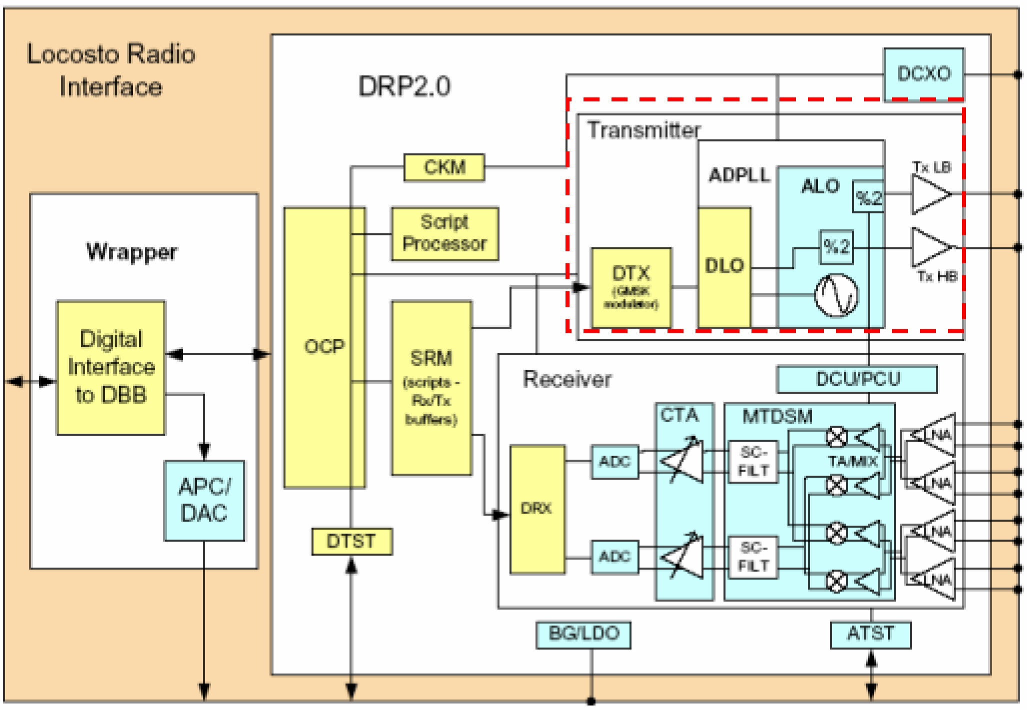


Figure 9: Locosto Transmit Block Diagram

2.4.2 Digitally- Controlled Crystal Oscillator (DCXO)

The DCXO system comprises an external crystal Y101, DCXO core based on Colpitts oscillator, a switching capacitor array, amplitude control loop and a current DAC. It also includes a startup system to control the startup sequence of the bandgap reference and the LDO voltage regulator for the DCXO that is based on a 32 KHz clock. DCXO (Digitally Controlled Crystal Oscillator) is a digitally tunable crystal oscillator centered at 26MHz for GSM applications with the step size of ~0.01ppm of the 26MHz. Both the amplitude and the frequency of oscillation are digitally controllable. Figure 10 shows the top level schematic of DCXO. Major components of DCXO includes a Colpitts oscillator core with negative resistance, 14-bit AFC fine frequency control capacitor DAC, plus an 10-bits coarse frequency control capacitor DAC; an 8-bit programmable current source (IDAC), a peak detector circuit, an ADC, a digital amplitude control loop, and an output buffer.

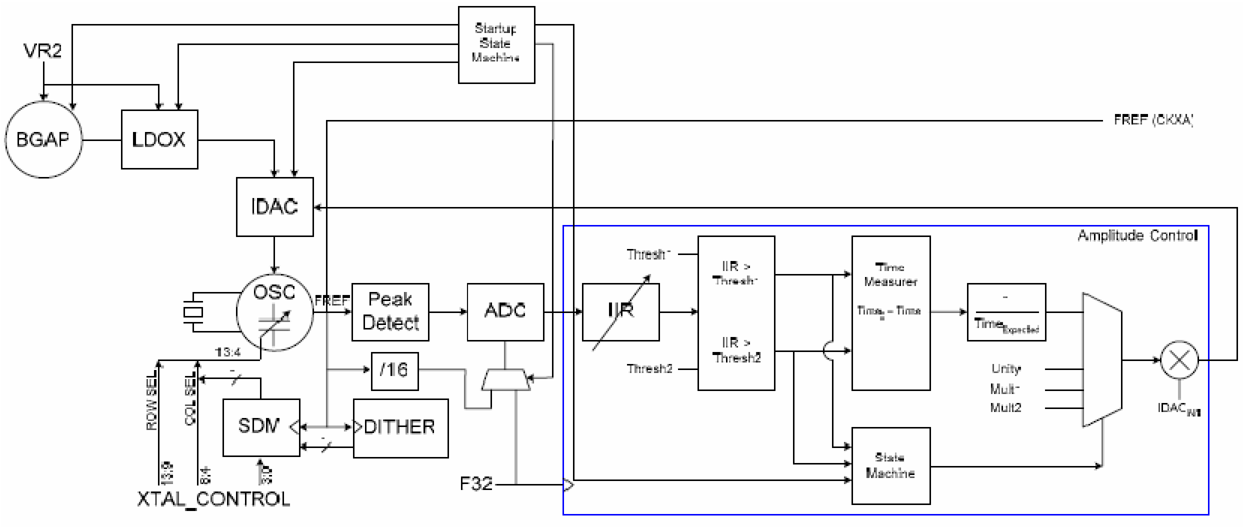


Figure 80: DCXO Block Diagram

The DCXO system is shown in Figure 10 including the power management. VR2 (from Triton/Triton-Lite) is used to power this system. At the heart of the DCXO system is the DCXO core that consists of a Colpitts oscillator with an 8-bit current DAC that can be used to change the loop gain of the DCXO core. The oscillator frequency can be tuned by controlling a bank of capacitors organized as an array in a very similar fashion to the construction of D/A converters. By selecting more capacitance, the oscillator frequency can be reduced and vice versa. The capacitors are selected by independently controlling rows and columns of the array through a thermometer encoded row/column selection. The smallest capacitor is dithered with first order sigma-delta modulation to achieve fractional resolution. The output of DCXO is available to the external world through the FREF buffer.

The system level control of DCXO basically can be separated by two categories: Frequency control and amplitude control. Frequency control is accomplished in three steps:

Coarse frequency control using segmented feedback capacitor inside the Colpitts oscillator

Fine Frequency Control using 1024 unit tuning capacitors

Fractional Fine Frequency control using Sigma-Delta Dithering of FFC unit capacitor
LDOX: Because of the low phase noise requirements, DCXO is provided with its own LDO voltage regulator (LDOX)

Oscillation Amplitude Control is accomplished by varying the current to the Colpitts Gm transistor. This functionality is implemented using a current DAC (IDAC block)

2.5 RF TX PA

The TX signal outputs at **TXLB** Locosto Plus **Pin F17** (low-band) and **TXHB** Locosto Plus **Pin G17** (high-band). The high-band signal passes through R202, and the low-band signal passes through R201. The SKY77318 PA IC U201, has two independent paths (one for the high-band signal and one for the low-band signal). A linear power amplifier in each path. The SKY77318 U201 also contains band-select switch circuitry to select GSM (logic0) or DCS/PCS (logic1) as determined from the **Band Select(BS) Pin 1** signal. The module consists of separate GSM850/900 PA and DCS1800/PCS1900 PA blocks, impedance-matching circuitry for 50Ω input and output impedances, and a Power Amplifier Control (**APC** SKY77318 **Pin 20**) block with an internal current-sense resistor.

The amplified RF output signal feeds out of SKY77318 from **Pin 15** for high-band and **Pin 11** for low-band. The high-band signal enters the T/R Switch SW201 **Pin 3**, and the low-band signal enters the Antenna Switch U700 **Pin 5.** The T/R Switch provides isolation between the various receiver and transmitter paths as they connect to the RF switch JP201 **Pin 1**. For Antenna Switch settings, see **Section 1.1: Band Selection.**

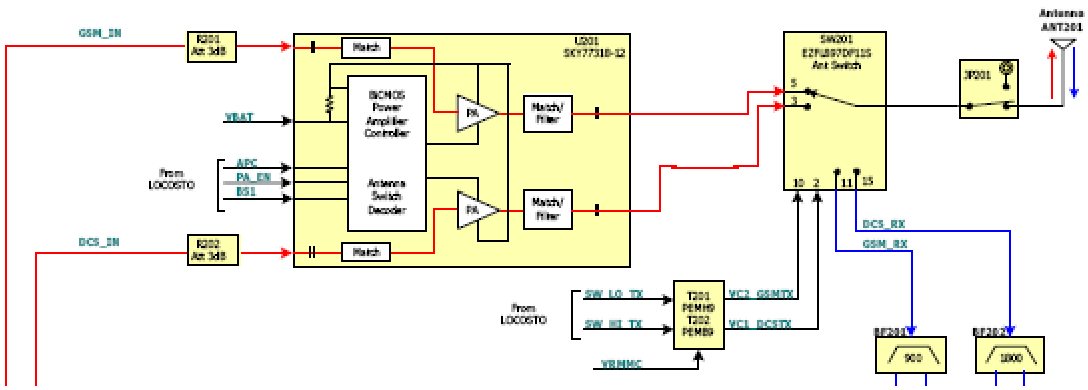


Figure 11: Power Amplifier and Antenna Switch

2.6 TX PA Power Control in SKY77318 U201

Figure 13 shows the Integrated Power Amplifier Control (iPAC) function along with SKY77318 proven quad-band PA architecture and BiCMOS current buffering bias scheme. The iPAC circuitry generally operates independently of other device subcircuits and serves to make the RF output power a predictable function of the **APC** SKY77318 **Pin 20** (V_{APC}) control voltage over variations in supply, temperature, and process. Top-level performance specifications, with exception of those directly associated with power control (or the range of **APC** control voltage), are not altered by placing the device into internal closed loop operation with the **PAENA** **(**PAC Enable**)** signal. Thus, the iPAC function of the SKY77318 can be analyzed separately from the general power amplifier performance.

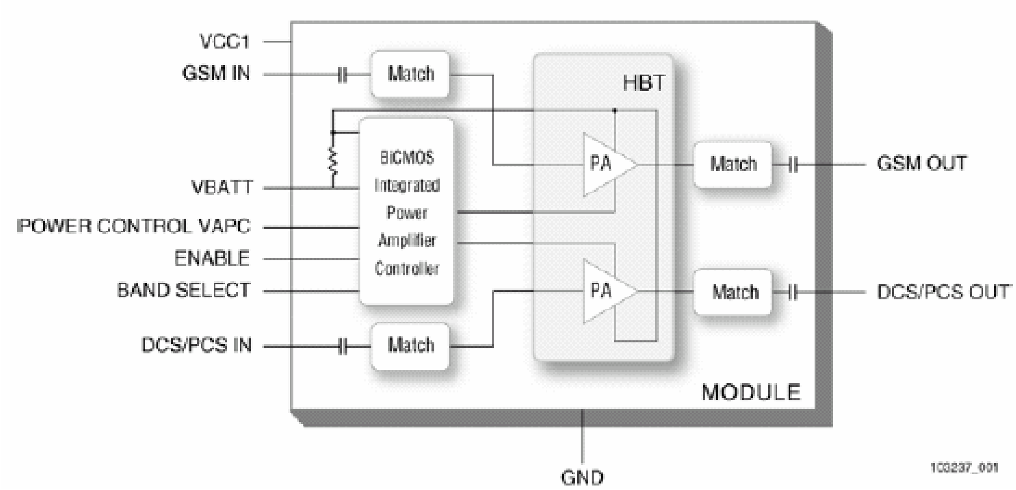


Figure 12: Skyworks 77318 Function Block Diagram

3 Triton-Lite Monitoring ADC

The monitoring section includes a 10-bit ADC and 10-bit/9-word RAM. The ADC monitors:

- Four internal analog values:
  – Battery voltage (**VBAT**)
  – Battery charger voltage (**VCHG**)
  – Current charger (current-to-voltage (I-to-V) converter) (**ICHG)**
  – Backup battery voltage (**VBACKUP**)
- Five external analog values:
  – ADIN3: **MODE_DETECT** Triton-Lite **Pin B7** for detect download cable or headset.
  – ADIN4: not used
  – ADIN5: **BAT_TEMP** Triton_Lite **Pin F8** for monitor the battery temperature.

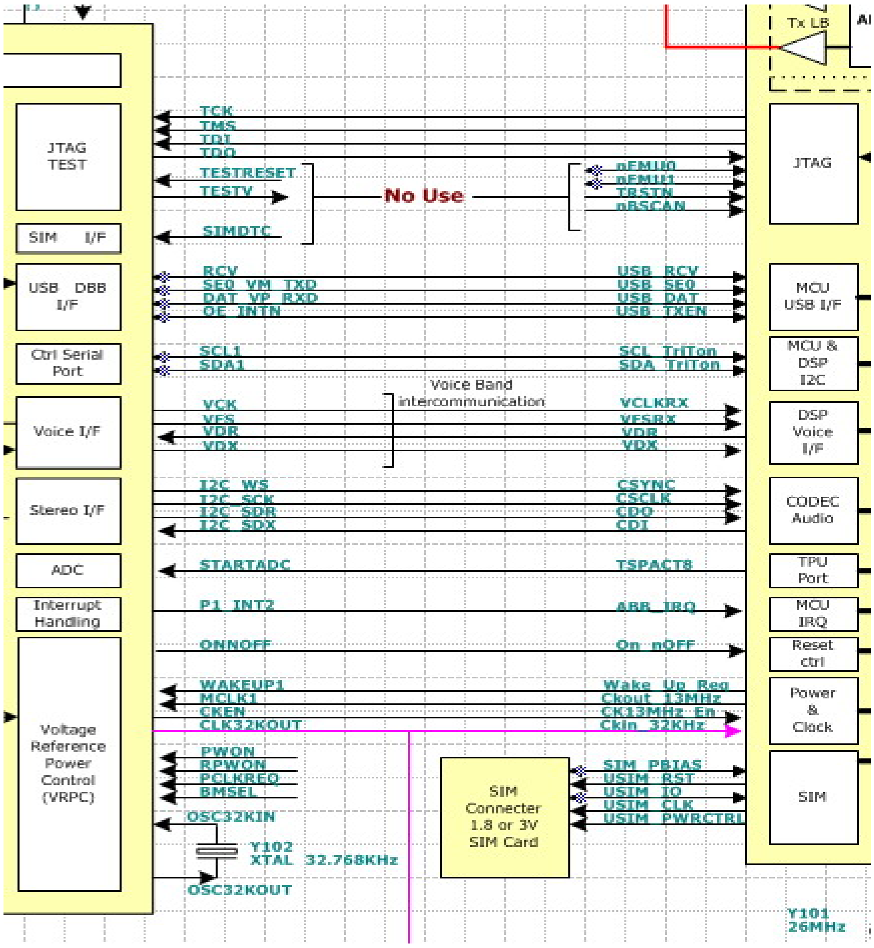


Figure 13: Baseband interface

4 Baseband Serial Port (BSP)

The baseband serial port (BSP) is a bidirectional (transmit/receive) serial port. Both receive and transmit operations are double-buffered and permit a continuous communication stream. Format is a 16-bit data packet with frame synchronization.

The CK13M master clock is used as a clock for both transmit and receive. The BSP allows read and write access of all internal registers under the arbitration of the internal bus controller. But its transmit path is allocated to the BDL path during burst reception for I and Q data transmissions.

5 Microcontroller Serial Port (USP)

The microcontroller serial port (USP) is a synchronous serial port. It consists of three terminals: data transmit (**MCUDI** Syren **Pin K3**), data receive (**MCUDO** Syren **Pin L3**), and port enable (**MCUEN0** Syren **Pin M2**). The clock signal is the CK13M master clock.

Transfers are initiated by the external microcontroller, which pushes data into the USP via the **MCUDO**, while synchronous data contained in the transmit buffer of the USP is pushed out via the **MCUDI**. The USP allows read and write access of all internal registers under the arbitration of the internal bus controller.

6 General purposes I/O (GPIO)

LOCOSTO-Plus provides 47 GPIOs in read or write mode by internal registers.

GPIO Pin	Used As.	Description
GPIO0	**HS_HOOK Pin M6**	Headset Hook
GPIO1	**HS_BIAS Pin K8**	Enable Headset BIAS
GPIO2	**HS_EN Pin T2**	Enable analog switch in data cable or headset MIC
GPIO3	**USB_Boot Pin T10**	Connect to R112 0Ohm PD resister
GPIO4	**CDI Pin R9**	Used as Stereo I/F signal
GPIO5	**TSPACT8 Pin N9**	Used as Triton-Lite STARTADC
GPIO6	**A21 Pin F3**	Used as Memory I/F A21
GPIO7	**FM_nINT Pin G6**	detect the interrupt from FM
GPIO8	**KBR4 Pin F10**	Used as Key board I/F KBR4
GPIO9	**KBC4 Pin B12**	Used as Key board I/F KBC4
GPIO10	**nEMU0 Pin C11**	No Use
GPIO11	**nEMU1 Pin D10**	No Use
GPIO12	**KEY_BL Pin B11**	Keypad LED enable signal
GPIO13	**LCD_nCS_0 Pin E10**	No Use
GPIO14	**LCD_STB Pin B10**	No Use
GPI015	**AUDAMP_SD Pin F9**	Enable Audio Amplifier shutdown pin
GPI016	**LCM_ID Pin D9**	LCM_ID signal
GPI017	**LCD_nCS_1 Pin B9**	No Use
GPI018	**HW_ID Pin A6**	Connect to a PU resister R119
GPI019	**Pin F8**	No Use
GPI020	**SIM_IO Pin E7**	To control transistor T703 for solving SIM initial issue
GPI021	**LEDLCM_EN Pin A5**	For controller the LCD Back Light Driver
GPI022	**HS_DETECT Pin C6**	Headset plug-in detection
GPI023	**SPI_CLK Pin G9**	Used as SPI I/F SPI_CLK
GPI024	**SPI_SOMI Pin F7**	No Use
GPI025	**SPI_SIMO Pin C5**	Used as SPI I/F SPI_SIMO
GPI026	**Charging_end Pin E6**	To control transistor T502
GPI027	**SPI_nCS Pin G8**	Used as SPI I/F SPI_nCS
GPI028	**Pin C4**	No Use
GPI029	**Charge_Protect Pin G7**	U501 alert signal when OCP/OVP event happened
GPI030	**UART_EN_RX B3**	select earphone or RS232-RX path
GPI031	**ND_WE Pin C3**	No Use
GPI032	**ND_CLE Pin F6**	Connect to a PU resister R133
GPI033	**FM_RESET Pin H8**	FM IC enable pin
GPI034	**ND_RnB Pin C2**	Connect to a PU resister R123
GPI035	**Pin F5**	No Use
GPI036	**Pin D2**	No Use
GPI037	**A23 Pin H7**	Used as Memory I/F A23
GPI038	**nCS0 Pin E3**	Used as Memory I/F nCS0
GPI039	**A22 Pin G5**	Used as Memory I/F A22
GPI040	**WAIT Pin M3**	Used as Memory I/F WAIT
GPI041	**nFADV Pin J7**	Used as Memory I/F nFADV

GPI042	**CKM Pin L6**	Used as Memory I/F CLM
GPI043	**MCSI_CK Pin N3**	Connect to a PD resister R108
GPI044	**HS_MIC_OFF Pin M5**	To turn OFF headset MIC
GPI045	**MCSI_TX Pin K7**	Connect to a PD resister R110
GPI046	**EN_FMVAD Pin P2**	enable 2.8V for FM, analog switch, level shfit
GPI047	**EN_FMVIO Pin N5**	enable 1.8V for FM, analog switch, level shfiter

7 CSTN LCD Display

This display is a color STN Liquid Crystal Display (CSTN) of glass construction with black pixels on a white background. The display consists of 128(RGB) x 128 pixels with 65K colors based on software settings.

Driver IC in chip-on-glass(COG) package. This LCM is used one chip LED on the Backlight.

i. Display Type: ***CSTN***
ii. Reflector Type: ***Transmissive***
iii. Pixel Resolution: 128 x RGB x 128
iv. Pixel Pitch: 0.213mm
v. Number of Colors or Levels of Grayscale: 65K/8 based on software setting
vi. Active Area: 27.252 x 27.249
vii. Viewing Area: 29.264 x 29.264
viii. Overall LCD Thickness: 3.0mm
ix. Glass Dimensions: Top Glass: 32.2 × 31.46 × 0.5, Bottom Glass: 32.2 × 36.96 × 0.5
x. Operating Temperature Range: - 20°C to + 70°C without loss of function.
xi. Storage Temperature Range: - 30°C to + 80°C without loss of function.
xii. Outline Dimension (WxHxT) : 36.7 x 49.15 x 3.0 mm
xiii. Weight :6 g

For W206, the 65K CSTN LCD display is controlled by the SPI (Serial Port Interface) and GPIO interface of Locosto-Plus. Figure shows the pin connections between CSTN LCD and Locosto-Plus. And the functions of those pins are described as the following:

SPI_SIMO – LCD serial data bus from Locosto-Plus

SPI_CLK – LCD serial clock derived from reference 13MHz clock

SPI_nCS – This is used as Chip Enable for the LCD.

LCM_RESET – LCD reset

VR2V8 – LCD driver IC power supply

VRIO – LCD driver IC IO supply

LED+ – LCD backlight LED power supply

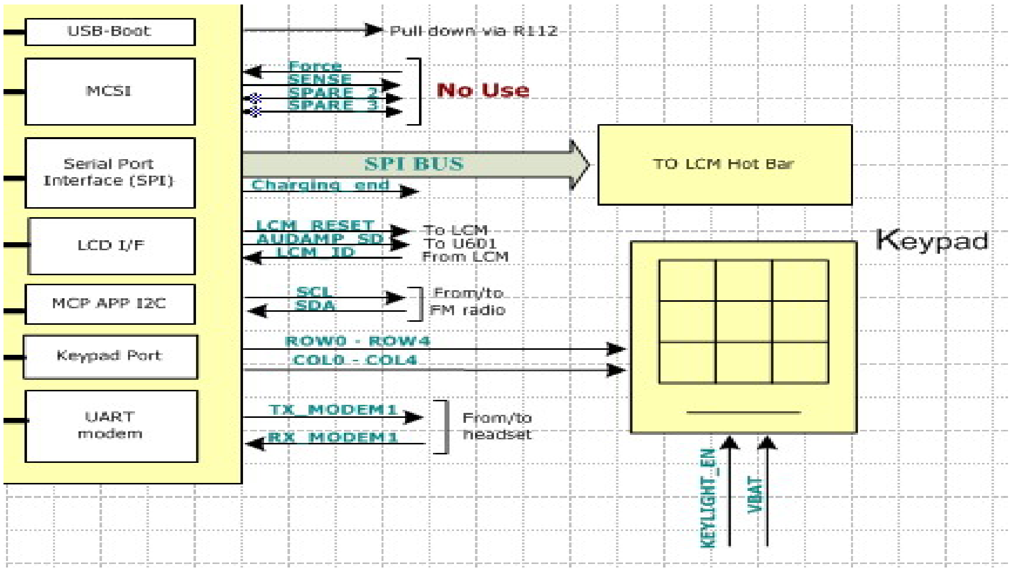


Figure 14: The pin connections of CSTN LCD and U101 Locosto-Plus

7.1 Display Backlights

The Display backlights are provided by the control signal **LEDLCM_EN** Locosto-Plus **Pin A5.** After **LEDLCM_EN** Locosto-Plus **Pin A5** control signal turned on, Charge Pump U701 will charge the flying capacitor (C702) to supply 5V for single LED in LCM. On another side, when **LEDLCM_EN** Locosto-Plus **Pin B11** control signal is high, the keypad light will be turned on.

8 32kHz RTC

The Real-time Clock Interface is part of the Triton-Lite U103 in use with the crystal Y102. The clock signal is running on 32kHz as reference for the clock module and as deep sleep clock.

9 SIM Card Circuit

To allow the use of both 1.8V and 2.8V SIM card types, there is a SIM level-shifter module in the Locosto-Plus U101. The SIM card digital interface ensures the translation of logic levels between the Locosto-Plus U101 device and the SIM card J701 for the transmission of three different signals:

USIM_IO – Data Communications path between SIM connector J701 **Pin 2** and Locosto-Plus **Pin P11**

USIM_CLK – SIM data Clock from Locosto-Plus **Pin P10**

USIM_RST – SIM Reset from Locosto-Plus **Pin N11**

VRSIM is an LDO voltage regulator providing the power supply to the SIM card driver of the Triton-Lite device.

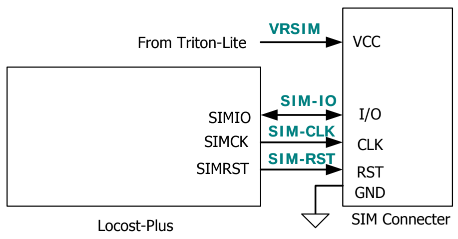


Figure 15: SIM interface

9.1 SIM Card Supply Voltage Generation

To accommodate the 1.8V or 2.9V SIM cards, the Triton-Lite includes an LDO voltage regulator that delivers supply voltage **Pin A3** to the SIM module.

The LDO voltage regulator is configured to generate the 1.8V or 2.9V (**VRSIM** U103 **Pin A3**) supply. The **VRSIM** J701 **Pin 4 and 5** terminals are decoupled by a capacitor (C709).

10 Keypad

The keyboard is connected to the chip using:

ROW0-ROW4 (**KBR[0:5]**) input pins for row lines

COL0-COL4 (**KBC[0:5]**) output pins for column lines

If a key button of the keyboard matrix is pressed, the corresponding row and column lines are shorted.

To allow key press detection, all input pins (**KBR[0:5]**) are pulled up to VCC and all output pins (**KBC[0:5]**) are driving a low level. Any action on a button will generate an interrupt to the microcontroller which will, as answer, scan the column lines with the sequence describe below.

This sequence is written to allow detection of simultaneous press actions on several key buttons.

	RESET	IDLE	KEYBOARD SCANNING						IDLE
KBC(0)	1	0	1	0	1	1	1	1	0
KBC(1)	1	0	1	1	0	1	1	1	0
KBC(2)	1	0	1	1	1	0	1	1	0
KBC(3)	1	0	1	1	1	1	0	1	0
KBC(4)	1	0	1	1	1	1	1	0	0

Figure 16: Keyboard scanning sequence

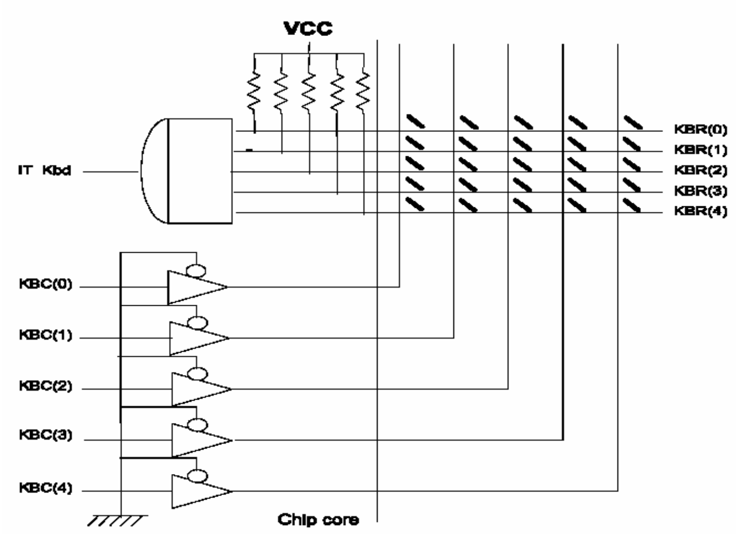


Figure 97: Keyboard connection

10.1 Keypad Matrix

The keypad matrix is as follow:

Function	Key	Col 0	Col 1	Col 2	Col 3	Col 4	Row 0	Row1	Row 2	Row 3	Row 4
1	S10	V					V				
2	S11	V						V			
3	S12	V							V		
SEND	S13	V								V	
4	S14		V				V				
5	S15		V					V			
6	S16		V						V		
UP	S17		V							V	
7	S18			V			V				
8	S19			V				V			
9	S20			V					V		
DOWN	S21			V						V	
*	S22				V		V				
0	S23				V			V			
#	S24				V				V		
LEFT	S25				V					V	
SOFT-L	S26					V	V				
MENU	S27					V		V			
SOFT-R	S28					V			V		
RIGHT	S29					V				V	
POWER/END	S30										V

11 Vibrator circuit

Triton-Lite U103 **Pin U12** is used to control the vibrational level. D708 is used to protection the vibrator. The **DAC** output voltage is 2.7V and drain current is around 80mA.

12 Memory

The W208 portable will be using the stacked combination memory parts that include flash die and PSRAM die. The Flash memory is 64Mbit size and the PSRAM memory is 16Mbit size.

ADD [1:23] – Address Bus for Flash memory/PSRAM.

DATA [0:15] – Data Bus for Flash memory/PSRAM

F1_VCC – This is provided Flash memory I/O voltage.

RnW – Read and Write allows information to be written or read from the memory devices.

nFOE – Flash and PSRAM output enable (Active Low).

FDP – The Flash reset/deep power-down mode control.

nCS3 – This is used as Chip Enable for the Flash Memory.

nCS0 – This is used as Chip Enable for the PSRAM Memory.

nBHE – Enable to address High Byte Information.

nBLE – Enable to address Low Byte Information.

VCCQ – This provides PSRAM memory power supply

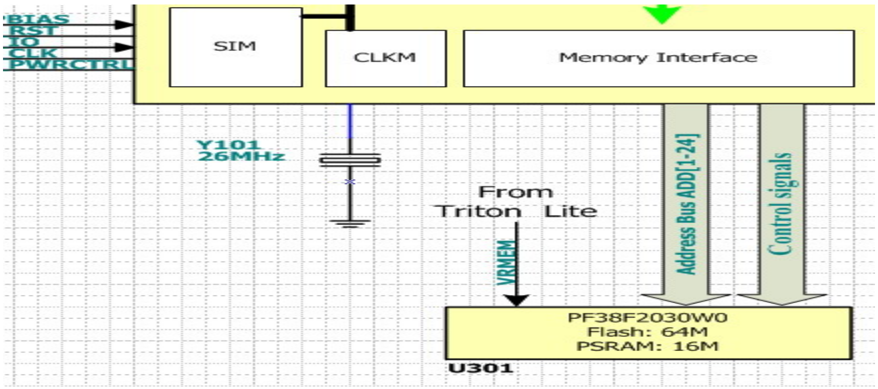


Figure 108: Memory interface

13 Power

13.1 Low-Dropout Voltage Regulators

The voltage regulation block consists of seven subblocks.

Several low-dropout (LDO) regulators perform linear voltage regulation. These regulators supply power to internal analog and digital circuits, to the Locosto-Plus IC U101 (DSP) processor, and to external memory.

The first LDO (**VRPLL** Triton-Lite **Pin T12**) is a programmable regulator that generates the supply voltages 1.3 V for Locosto-Plus IC U101.

The second LDO (**VRABB** Triton-Lite **Pin B2**) generates the supply voltage (2.8 V) for the Triton-Lite analog part.

The third LDO (**VRRTC** Triton-Lite **Pin N17**) is a power rail for embedded 32K real time clock used.

The fourth LDO (**VREXTH** Triton-Lite **Pin I17**) is a programmable regulator that generates the supply voltages 2.8 V for supplying an external peripheral to Locosto-Plus U101.

The fifth LDO (**VREXTL** Triton-Lite **Pin G17**) generates the supply external peripheral voltage (1.3 V) Triton-Lite U101.

The sixth LDO (**VRMMC** Triton-Lite **Pin T10**) is a programmable regulator that generates the supply an external MMC device voltages (2.8V).

The seventh LDO (**VRSIM** Triton-Lite **Pin A3**) is a programmable regulator for supply SIM-card and SIM-card device (2.8V).

The eighth LDO (**VRIO** Triton-Lite **Pin J16**) is a programmable regulator for supplying the I/O of the system (1.8V).

The ninth LDO (**VRMEM** Triton-Lite **Pin U11**) is a programmable regulator for supplying the external Flash memory (1.8V).

The Triton-Lite U103 allows three operating modes for each of these voltage regulators:

1. ACTIVE mode during which the regulator is able to deliver its full power.
2. SLEEP mode during which the output voltage is maintained with very low power consumption but with a low current capability (1mA).
3. OFF mode during which the output voltage is not maintained and the power consumption is null.

The regulators rise up in ACTIVE mode only and each of them has a regulation ready signal RSU. In switched-off and backup states of the mobile phone, the voltage regulators will be set to a SLEEP or OFF mode depending on the system requirements. The regulator voltages are decoupled by a low ESR capacitor connected across the corresponding VCC and ground terminals. Besides its voltage filtering function, this capacitor also has a voltage storage function that could give a delay for data protection purposes when the main battery is unplugged.

The third LDO (**VRRTC** Triton-Lite **Pin N17**) is a programmable regulator that generates the supply voltages 1.8 V for the real-time clock and the 32kHz oscillator located in the Locosto-Plus IC U101 (DSP) device during all modes. The main or backup battery supplies **VRRTC**.

13.2 Power Down Methods

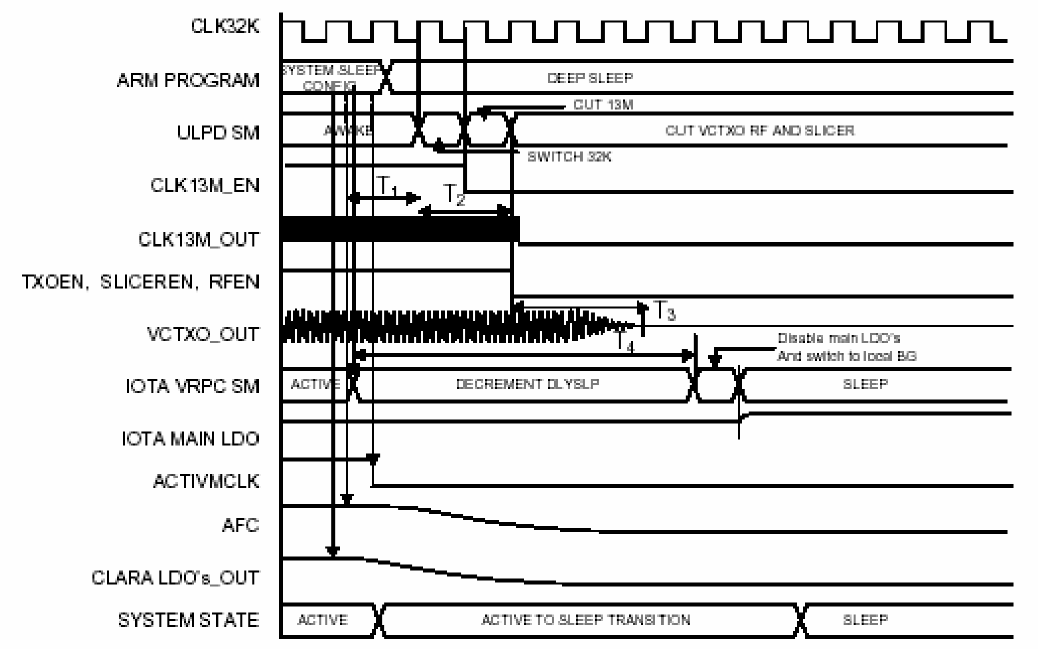
The phone is disabled by one of the following conditions:

1. Software-initiated power down.
   When the user requests to turn the phone off by pressing the POWER/END key, or put **RPWON TP11** to GND, or when a low battery voltage is detected by software through **VBATS** Syren **Pin K8** (typical value is 3.53V) measurement and therefore the phone turns off.
2. Hardware-initiated power down.
   On main battery remove or deep discharge, when the main battery voltage is lower than 2.8V.

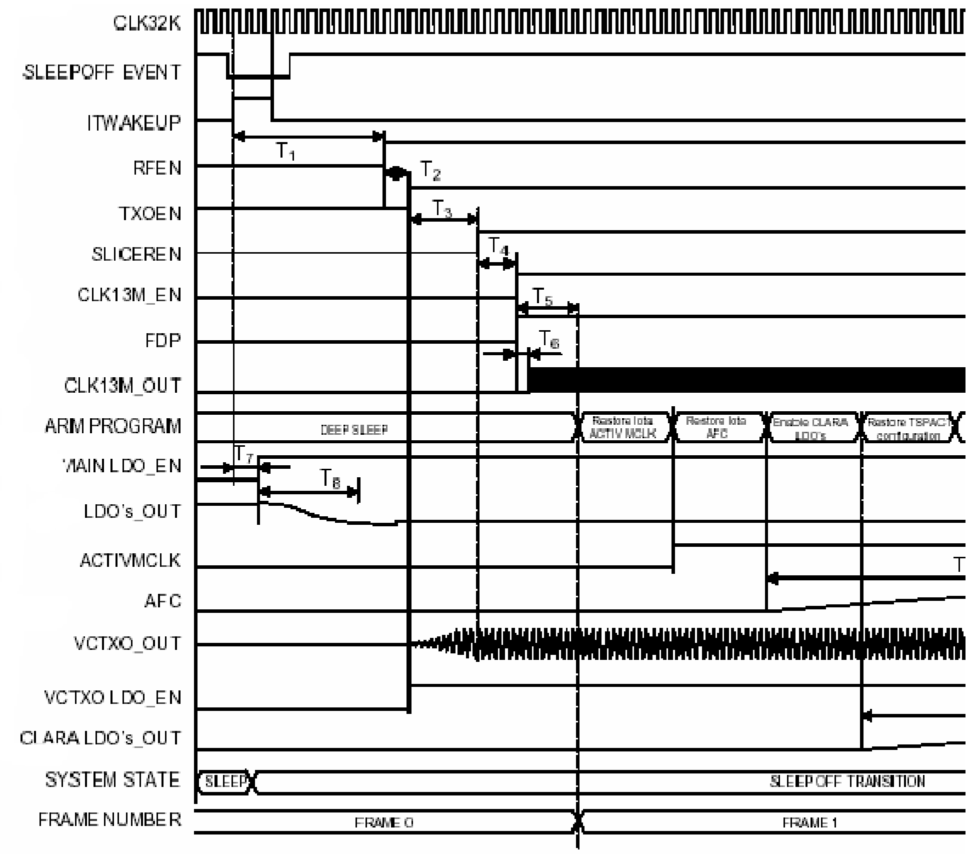
14 Sleep Module

The Sleep Module allowed for optimal power savings in idle modes. Triton-Lite U103 internal LDOs (VRIO, VRMAM, VRSIM, VRABB, VREXTL, VRPLL) have very low current consumption and can provide 1mA current.

14.1 Sleep Up Sequence



14.2 Sleep off Sequence



15 Power Tree

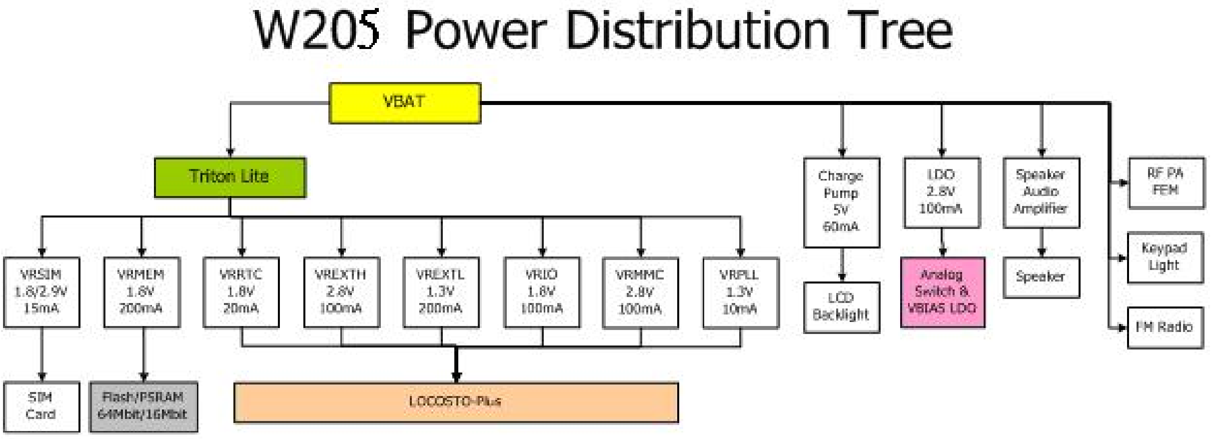


Figure 119: Power Distribution Tree

16 Charging Circuit and External Power

We can obtain power from battery and external charger. Power source via the accessory connector are not supported.

16.1 Battery Support

The Battery connecter J700 is made up of 4 contacts, these are

- Pin 1 – **VBAT- (BATTGND)**
- Pin 2 – **BAT_TEMP** is used to measure the Battery temperature during charging, fed from the battery connector to Triton-Lite U103 **Pin F8**
- Pin 3 – **DATA-EPROM for charge/discharge control (No Used for W370/ W375)**
- Pin 4 – **VBAT+**

16.2 Charger Support

When the battery voltage is less than 3.2V, and adapter is inserted, the charging system will enter the 'Pre-CHARGE' mode. The pre-charging current will pass through Triton-Lite pre-charge path and charger IC U501 (ISL9200). The current limit resisters, (R511), are set the safe magnitude of pre-charging current.

When a charger is plugged in and **VAC** is less than 6.85V, the Triton-Litw will enable U502 (P-MOSFET) to start charging process. The process starts charge state until **VAC** is full.

When the battery voltage is less than 3.2V (deeply discharged), the Battery Charge Interface (BCI) of Triton-Lite will enter the pre-charge mode (charging current is under 100mA) as soon as the charger is plugged-in. At this moment, software cannot control the charging process. Until battery voltage **VBAT** is larger than 3.2V, Triton-Lite will wake up and then enter to normal charging status. The normal charge will start as constant current mode (MAX current is 450mA). When the battery voltage is reach 4.15V, charging system will enter the constant voltage mode till minimum current is less than 50mA, then the charge process finishes. When the battery voltage **VBAT** is higher than 4.2V, U502 (P-MOSFET) will be turned off and stop charging.